

## Final datasheet

## EasyPACK™ module with CoolSiC™ Trench MOSFET and PressFIT / NTC

### Features

- Electrical features
  - $V_{DS} = 1200\text{ V}$
  - $I_{DN} = 100\text{ A}$  /  $I_{DRM} = 200\text{ A}$
  - Low inductive design
  - Low switching losses
  - High current density
  - Suitable Infineon gate drivers can be found under <https://www.infineon.com/gdfinder>
- Mechanical features
  - PressFIT contact technology
  - Integrated NTC temperature sensor
  - Rugged mounting due to integrated mounting clamps
  - AlN substrate with low thermal resistance



Typical appearance

### Potential applications

- High-frequency switching application
- DC/DC converter
- UPS systems
- DC charger for EV

### Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

### Description

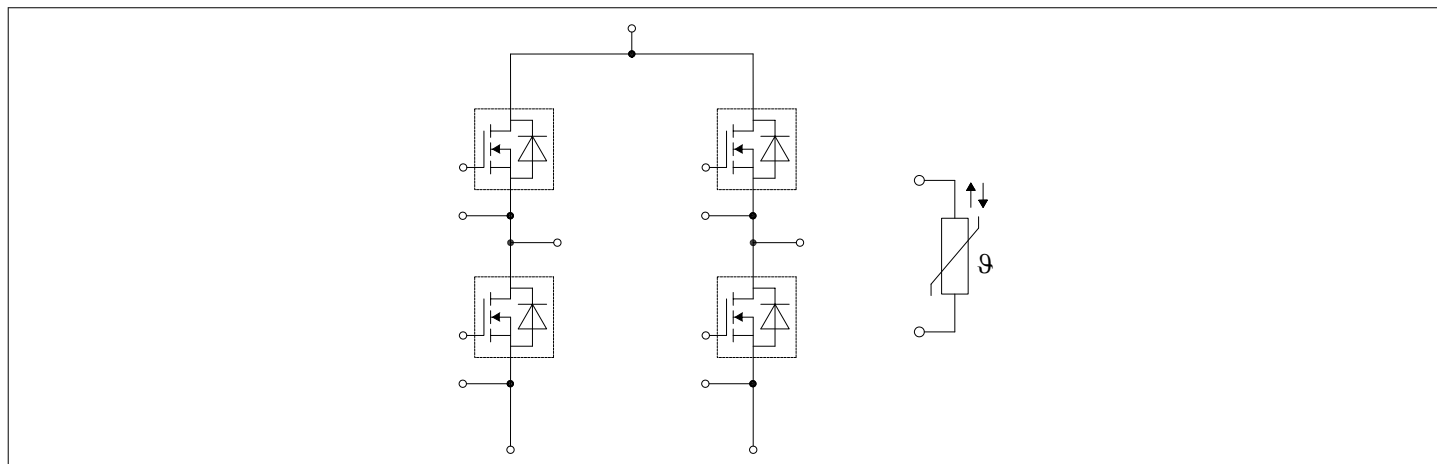


Table of contents

|   |                                |    |
|---|--------------------------------|----|
|   | Description .....              | 1  |
|   | Features .....                 | 1  |
|   | Potential applications .....   | 1  |
|   | Product validation .....       | 1  |
|   | Table of contents .....        | 2  |
| 1 | Package .....                  | 3  |
| 2 | MOSFET .....                   | 3  |
| 3 | Body diode (MOSFET) .....      | 5  |
| 4 | NTC-Thermistor .....           | 6  |
| 5 | Characteristics diagrams ..... | 7  |
| 6 | Circuit diagram .....          | 14 |
| 7 | Package outlines .....         | 15 |
| 8 | Module label code .....        | 16 |
|   | Revision history .....         | 17 |
|   | Disclaimer .....               | 18 |

## 1 Package

**Table 1** Insulation coordination

| Parameter                           | Symbol          | Note or test condition                         | Values | Unit |
|-------------------------------------|-----------------|------------------------------------------------|--------|------|
| Isolation test voltage              | $V_{ISOL}$      | RMS, $f = 50 \text{ Hz}$ , $t = 1 \text{ min}$ | 3.0    | kV   |
| Isolation test voltage NTC          | $V_{ISOL(NTC)}$ | RMS, $f = 50 \text{ Hz}$ , $t = 1 \text{ min}$ | 3.0    | kV   |
| Internal isolation                  |                 | basic insulation (class 1, IEC 61140)          | AIN    |      |
| Comparative tracking index          | $CTI$           |                                                | > 200  |      |
| Relative thermal index (electrical) | $RTI$           |                                                | 140    | °C   |

**Table 2** Characteristic values

| Parameter                                | Symbol        | Note or test condition             | Values |      |      | Unit |
|------------------------------------------|---------------|------------------------------------|--------|------|------|------|
|                                          |               |                                    | Min.   | Typ. | Max. |      |
| Stray inductance module                  | $L_{SCE}$     |                                    |        | 9    |      | nH   |
| Module lead resistance, terminals - chip | $R_{CC'+EE'}$ | $T_H = 25 \text{ °C}$ , per switch |        | 2.1  |      | mΩ   |
| Storage temperature                      | $T_{stg}$     |                                    | -40    |      | 125  | °C   |
| Mounting force per clamp                 | $F$           |                                    | 40     |      | 80   | N    |
| Weight                                   | $G$           |                                    |        | 39   |      | g    |

**Note:** The current under continuous operation is limited to 25 A rms per connector pin.

## 2 MOSFET

**Table 3** Maximum rated values

| Parameter                                   | Symbol    | Note or test condition                                                       | Values | Unit |
|---------------------------------------------|-----------|------------------------------------------------------------------------------|--------|------|
| Drain-source voltage                        | $V_{DSS}$ | $T_{vj} = 25 \text{ °C}$                                                     | 1200   | V    |
| Continuous DC drain current                 | $I_{DDC}$ | $T_{vj} = 175 \text{ °C}$ , $V_{GS} = 18 \text{ V}$<br>$T_H = 70 \text{ °C}$ | 100    | A    |
| Repetitive peak drain current               | $I_{DRM}$ | verified by design, $t_p$ limited by $T_{vjmax}$                             | 200    | A    |
| Gate-source voltage, max. transient voltage | $V_{GS}$  | $D < 0.01$                                                                   | -10/23 | V    |
| Gate-source voltage, max. static voltage    | $V_{GS}$  |                                                                              | -7/20  | V    |

**Table 4** Recommended values

| Parameter             | Symbol       | Note or test condition | Values  | Unit |
|-----------------------|--------------|------------------------|---------|------|
| On-state gate voltage | $V_{GS(on)}$ |                        | 15...18 | V    |

(table continues...)

**Table 4 (continued) Recommended values**

| Parameter              | Symbol        | Note or test condition | Values | Unit |
|------------------------|---------------|------------------------|--------|------|
| Off-state gate voltage | $V_{GS(off)}$ |                        | -5...0 | V    |

**Table 5 Characteristic values**

| Parameter                            | Symbol       | Note or test condition                                                                                                                                              |                                               | Values |       |      | Unit |
|--------------------------------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------|--------|-------|------|------|
|                                      |              |                                                                                                                                                                     |                                               | Min.   | Typ.  | Max. |      |
| Drain-source on-resistance           | $R_{DS(on)}$ | $I_D = 100\text{ A}$                                                                                                                                                | $V_{GS}=18\text{ V}, T_{vj}=25\text{ °C}$     |        | 8.1   | 12   | mΩ   |
|                                      |              |                                                                                                                                                                     | $V_{GS}=18\text{ V}, T_{vj}=125\text{ °C}$    |        | 13.1  |      |      |
|                                      |              |                                                                                                                                                                     | $V_{GS}=18\text{ V}, T_{vj}=175\text{ °C}$    |        | 17.4  |      |      |
|                                      |              |                                                                                                                                                                     | $V_{GS} = 15\text{ V}, T_{vj} = 25\text{ °C}$ |        | 9.7   |      |      |
| Gate threshold voltage               | $V_{GS(th)}$ | $I_D = 40\text{ mA}, V_{DS} = V_{GS}, T_{vj} = 25\text{ °C},$ (tested after 1ms pulse at $V_{GS} = +20\text{ V}$ )                                                  |                                               | 3.45   | 4.3   | 5.15 | V    |
| Total gate charge                    | $Q_G$        | $V_{DD}=800\text{ V}, V_{GS} = -3/18\text{ V}, T_{vj} = 25\text{ °C}$                                                                                               |                                               |        | 0.297 |      | μC   |
| Internal gate resistor               | $R_{Gint}$   | $T_{vj}=25\text{ °C}$                                                                                                                                               |                                               |        | 2.1   |      | Ω    |
| Input capacitance                    | $C_{ISS}$    | $f = 100\text{ kHz}, V_{DS}=800\text{ V}, V_{GS}=0\text{ V}$                                                                                                        | $T_{vj}=25\text{ °C}$                         |        | 8.8   |      | nF   |
| Output capacitance                   | $C_{OSS}$    | $f = 100\text{ kHz}, V_{DS}=800\text{ V}, V_{GS}=0\text{ V}$                                                                                                        | $T_{vj}=25\text{ °C}$                         |        | 0.42  |      | nF   |
| Reverse transfer capacitance         | $C_{rss}$    | $f = 100\text{ kHz}, V_{DS}=800\text{ V}, V_{GS}=0\text{ V}$                                                                                                        | $T_{vj}=25\text{ °C}$                         |        | 0.028 |      | nF   |
| $C_{OSS}$ stored energy              | $E_{OSS}$    | $V_{DS}=800\text{ V}, V_{GS} = -3/18\text{ V}, T_{vj} = 25\text{ °C}$                                                                                               |                                               |        | 172   |      | μJ   |
| Drain-source leakage current         | $I_{DSS}$    | $V_{DS} = 1200\text{ V}, V_{GS} = -3\text{ V}$                                                                                                                      | $T_{vj} = 25\text{ °C}$                       |        | 0.06  | 380  | μA   |
| Gate-source leakage current          | $I_{GSS}$    | $V_{DS} = 0\text{ V}, T_{vj} = 25\text{ °C}$                                                                                                                        | $V_{GS}=20\text{ V}$                          |        |       | 400  | nA   |
| Turn-on delay time (inductive load)  | $t_{d\ on}$  | $I_D = 100\text{ A}, R_{Gon} = 7.5\text{ Ω}, V_{DD} = 600\text{ V}, V_{GS} = -3/18\text{ V}, t_{dead} = 1000\text{ ns}, 0.1\text{ }V_{GS}\text{ to }0.1\text{ }I_D$ | $T_{vj} = 25\text{ °C}$                       |        | 40    |      | ns   |
|                                      |              |                                                                                                                                                                     | $T_{vj} = 125\text{ °C}$                      |        | 40    |      |      |
|                                      |              |                                                                                                                                                                     | $T_{vj} = 175\text{ °C}$                      |        | 40    |      |      |
| Rise time (inductive load)           | $t_r$        | $I_D = 100\text{ A}, R_{Gon} = 7.5\text{ Ω}, V_{DD} = 600\text{ V}, V_{GS} = -3/18\text{ V}, t_{dead} = 1000\text{ ns}, 0.1\text{ }I_D\text{ to }0.9\text{ }I_D$    | $T_{vj} = 25\text{ °C}$                       |        | 23    |      | ns   |
|                                      |              |                                                                                                                                                                     | $T_{vj} = 125\text{ °C}$                      |        | 22    |      |      |
|                                      |              |                                                                                                                                                                     | $T_{vj} = 175\text{ °C}$                      |        | 22    |      |      |
| Turn-off delay time (inductive load) | $t_{d\ off}$ | $I_D = 100\text{ A}, R_{Goff} = 0.51\text{ Ω}, V_{DD} = 600\text{ V}, V_{GS} = -3/18\text{ V}, 0.9\text{ }V_{GS}\text{ to }0.9\text{ }I_D$                          | $T_{vj} = 25\text{ °C}$                       |        | 40    |      | ns   |
|                                      |              |                                                                                                                                                                     | $T_{vj} = 125\text{ °C}$                      |        | 44    |      |      |
|                                      |              |                                                                                                                                                                     | $T_{vj} = 175\text{ °C}$                      |        | 45    |      |      |

**(table continues...)**

**Table 5** (continued) Characteristic values

| Parameter                                 | Symbol       | Note or test condition                                                                                                                                                                                                                           | Values                   |       |      | Unit |
|-------------------------------------------|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|-------|------|------|
|                                           |              |                                                                                                                                                                                                                                                  | Min.                     | Typ.  | Max. |      |
| Fall time (inductive load)                | $t_f$        | $I_D = 100\text{ A}$ , $R_{Goff} = 0.51\ \Omega$ ,<br>$V_{DD} = 600\text{ V}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$0.9\ I_D$ to $0.1\ I_D$                                                                                                          | $T_{vj} = 25\text{ °C}$  | 15    |      | ns   |
|                                           |              |                                                                                                                                                                                                                                                  | $T_{vj} = 125\text{ °C}$ | 15    |      |      |
|                                           |              |                                                                                                                                                                                                                                                  | $T_{vj} = 175\text{ °C}$ | 16    |      |      |
| Turn-on energy loss per pulse             | $E_{on}$     | $I_D = 100\text{ A}$ , $V_{DD} = 600\text{ V}$ ,<br>$L_\sigma = 15\text{ nH}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$R_{Gon} = 7.5\ \Omega$ , $di/dt =$<br>$5.38\text{ kA}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ ),<br>$t_{dead} = 1000\text{ ns}$  | $T_{vj} = 25\text{ °C}$  | 2.27  |      | mJ   |
|                                           |              |                                                                                                                                                                                                                                                  | $T_{vj} = 125\text{ °C}$ | 2.51  |      |      |
|                                           |              |                                                                                                                                                                                                                                                  | $T_{vj} = 175\text{ °C}$ | 2.79  |      |      |
| Turn-on energy loss per pulse, optimized  | $E_{on,o}$   | $I_D = 100\text{ A}$ , $V_{DD} = 600\text{ V}$ ,<br>$L_\sigma = 15\text{ nH}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$R_{Gon,o} = 4.7\ \Omega$ , $di/dt =$<br>$6.86\text{ kA}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ ),<br>$t_{dead} = 100\text{ ns}$ | $T_{vj} = 25\text{ °C}$  | 1.56  |      | mJ   |
|                                           |              |                                                                                                                                                                                                                                                  | $T_{vj} = 125\text{ °C}$ | 1.66  |      |      |
|                                           |              |                                                                                                                                                                                                                                                  | $T_{vj} = 175\text{ °C}$ | 1.77  |      |      |
| Turn-off energy loss per pulse            | $E_{off}$    | $I_D = 100\text{ A}$ , $V_{DD} = 600\text{ V}$ ,<br>$L_\sigma = 15\text{ nH}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$R_{Goff} = 0.51\ \Omega$ , $dv/dt =$<br>$44.5\text{ kV}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ )                                | $T_{vj} = 25\text{ °C}$  | 0.22  |      | mJ   |
|                                           |              |                                                                                                                                                                                                                                                  | $T_{vj} = 125\text{ °C}$ | 0.22  |      |      |
|                                           |              |                                                                                                                                                                                                                                                  | $T_{vj} = 175\text{ °C}$ | 0.24  |      |      |
| Thermal resistance, junction to heat sink | $R_{thJH}$   | per MOSFET, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$                                                                                                                                                                              |                          | 0.402 |      | K/W  |
| Temperature under switching conditions    | $T_{vj\ op}$ |                                                                                                                                                                                                                                                  | -40                      |       | 175  | °C   |

**Note:** The selection of positive and negative gate-source voltages impacts losses and the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Note AN 2018-09 and AN 2021-13 must be considered to ensure sound operation of the device over the planned lifetime.

$T_{vj,op} > 150\text{ °C}$  is allowed for operation at overload conditions for MOSFET and body diode. For detailed specifications, please refer to AN 2021-13

### 3 Body diode (MOSFET)

**Table 6** Maximum rated values

| Parameter                     | Symbol   | Note or test condition                            |                      | Values | Unit |
|-------------------------------|----------|---------------------------------------------------|----------------------|--------|------|
| DC body diode forward current | $I_{SD}$ | $T_{vj} = 175\text{ °C}$ , $V_{GS} = -3\text{ V}$ | $T_H = 70\text{ °C}$ | 60     | A    |

**Table 7** Characteristic values

| Parameter                          | Symbol      | Note or test condition                                                                                                                                                              | Values                    |      |      | Unit          |
|------------------------------------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------|------|------|---------------|
|                                    |             |                                                                                                                                                                                     | Min.                      | Typ. | Max. |               |
| Forward voltage                    | $V_{SD}$    | $I_{SD} = 100 \text{ A}$ , $V_{GS} = -3 \text{ V}$                                                                                                                                  | $T_{vj} = 25 \text{ °C}$  | 4.2  | 5.35 | V             |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 3.9  |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 3.8  |      |               |
| Peak reverse recovery current      | $I_{rrm}$   | $I_{SD} = 100 \text{ A}$ , $di_s/dt = 5.38 \text{ kA}/\mu\text{s}$ , $V_{DD} = 600 \text{ V}$ , $V_{GS} = -3 \text{ V}$ , $t_{dead} = 1000 \text{ ns}$                              | $T_{vj} = 25 \text{ °C}$  | 53   |      | A             |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 74   |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 90   |      |               |
| Recovered charge                   | $Q_{rr}$    | $I_{SD} = 100 \text{ A}$ , $di_s/dt = 5.38 \text{ kA}/\mu\text{s}$ , $V_{DD} = 600 \text{ V}$ , $V_{GS} = -3 \text{ V}$ , $t_{dead} = 1000 \text{ ns}$                              | $T_{vj} = 25 \text{ °C}$  | 0.89 |      | $\mu\text{C}$ |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 1.64 |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 2.34 |      |               |
| Reverse recovery energy            | $E_{rec}$   | $I_{SD} = 100 \text{ A}$ , $di_s/dt = 5.38 \text{ kA}/\mu\text{s}$ ( $T_{vj} = 175 \text{ °C}$ ), $V_{DD} = 600 \text{ V}$ , $V_{GS} = -3 \text{ V}$ , $t_{dead} = 1000 \text{ ns}$ | $T_{vj} = 25 \text{ °C}$  | 0.17 |      | mJ            |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 0.36 |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 0.47 |      |               |
| Reverse recovery energy, optimized | $E_{rec,o}$ | $I_{SD} = 100 \text{ A}$ , $di_s/dt = 6.86 \text{ kA}/\mu\text{s}$ ( $T_{vj} = 175 \text{ °C}$ ), $V_{DD} = 600 \text{ V}$ , $V_{GS} = -3 \text{ V}$ , $t_{dead} = 100 \text{ ns}$  | $T_{vj} = 25 \text{ °C}$  | 0.18 |      | mJ            |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 0.21 |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 0.26 |      |               |

## 4 NTC-Thermistor

**Table 8** Characteristic values

| Parameter              | Symbol       | Note or test condition                                        | Values |      |      | Unit       |
|------------------------|--------------|---------------------------------------------------------------|--------|------|------|------------|
|                        |              |                                                               | Min.   | Typ. | Max. |            |
| Rated resistance       | $R_{25}$     | $T_{NTC} = 25 \text{ °C}$                                     |        | 5    |      | k $\Omega$ |
| Deviation of $R_{100}$ | $\Delta R/R$ | $T_{NTC} = 100 \text{ °C}$ , $R_{100} = 493 \text{ }\Omega$   | -5     |      | 5    | %          |
| Power dissipation      | $P_{25}$     | $T_{NTC} = 25 \text{ °C}$                                     |        |      | 20   | mW         |
| B-value                | $B_{25/50}$  | $R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$  |        | 3375 |      | K          |
| B-value                | $B_{25/80}$  | $R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$  |        | 3411 |      | K          |
| B-value                | $B_{25/100}$ | $R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$ |        | 3433 |      | K          |

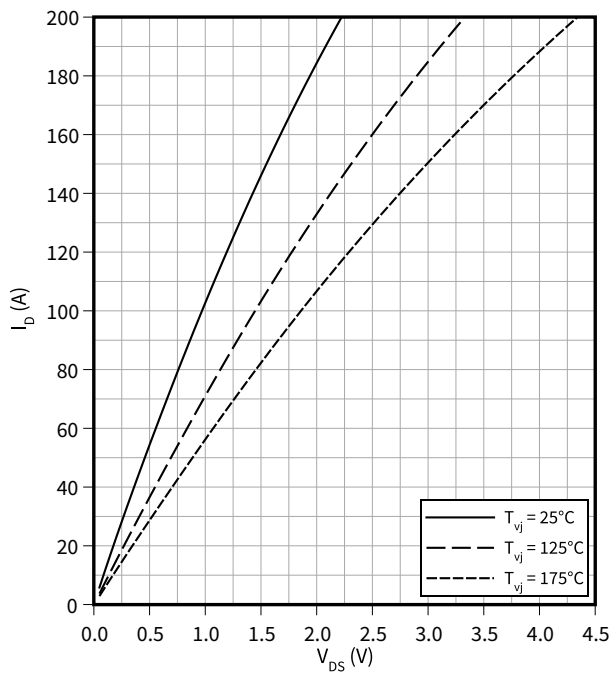
**Note:** For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4.

5 Characteristics diagrams

Output characteristic (typical), MOSFET

$I_D = f(V_{DS})$

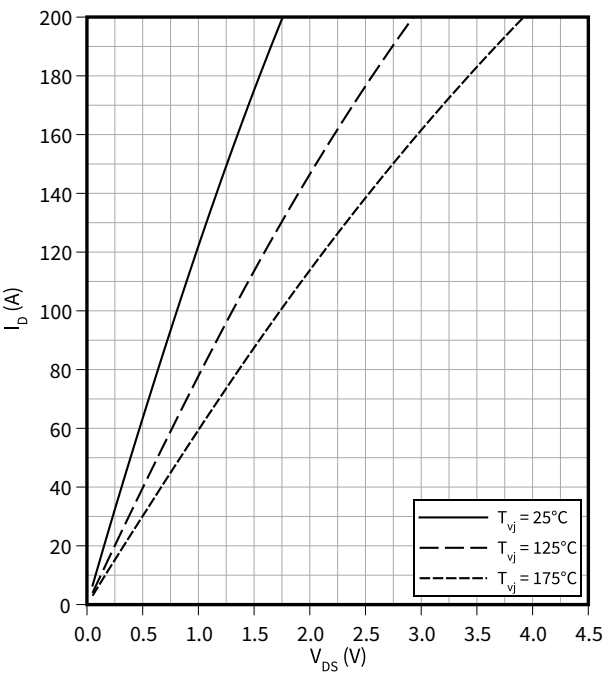
$V_{GS} = 15\text{ V}$



Output characteristic (typical), MOSFET

$I_D = f(V_{DS})$

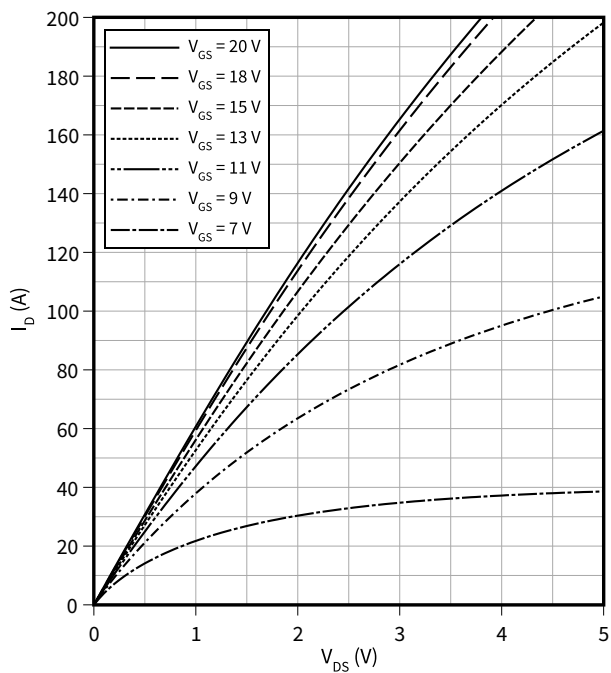
$V_{GS} = 18\text{ V}$



Output characteristic field (typical), MOSFET

$I_D = f(V_{DS})$

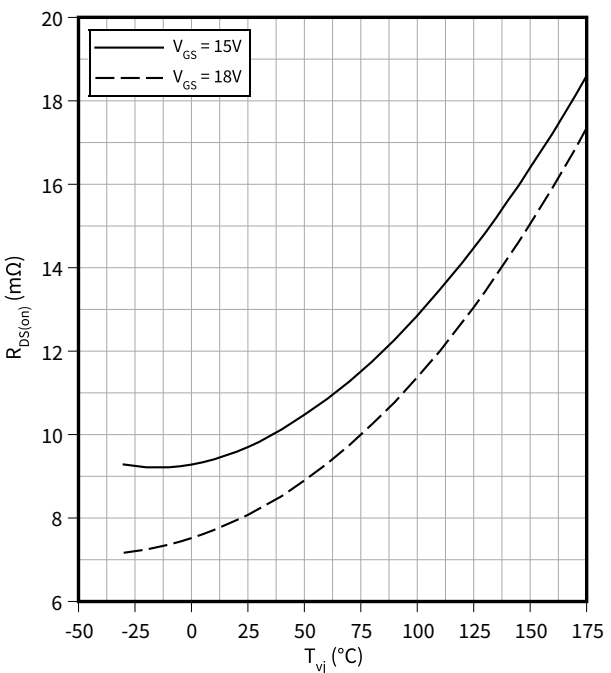
$T_{vj} = 175\text{ °C}$



Drain source on-resistance (typical), MOSFET

$R_{DS(on)} = f(T_{vj})$

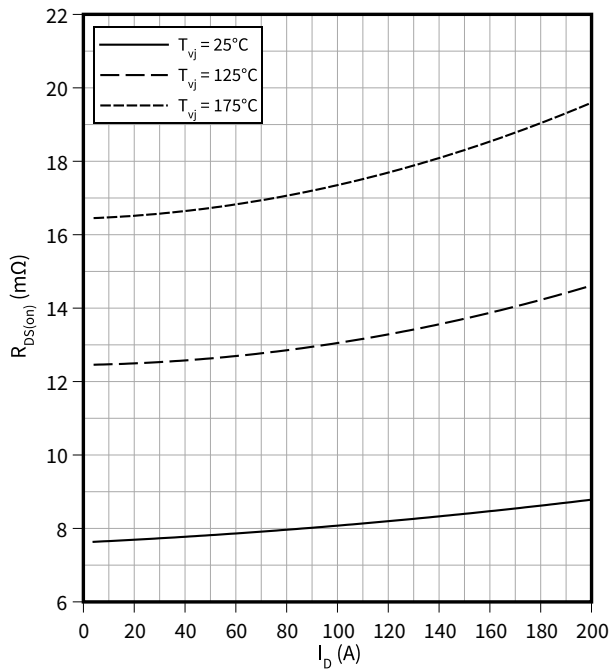
$I_D = 100\text{ A}$



5 Characteristics diagrams

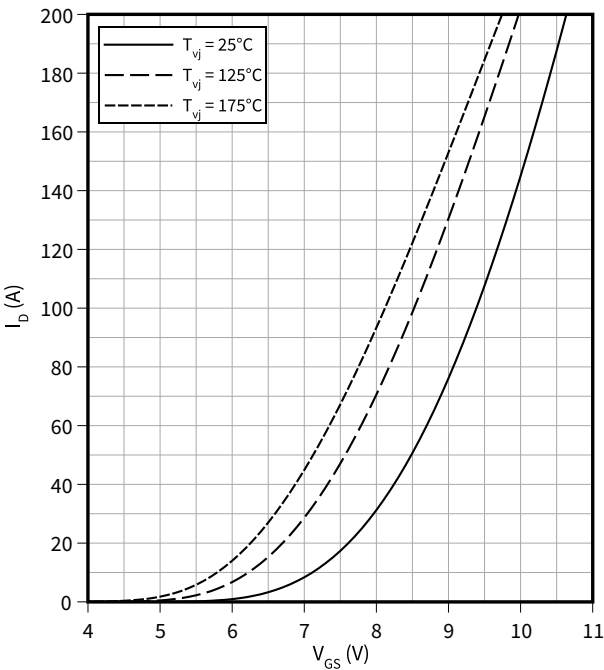
Drain source on-resistance (typical), MOSFET

$R_{DS(on)} = f(I_D)$   
 $V_{GS} = 18\text{ V}$



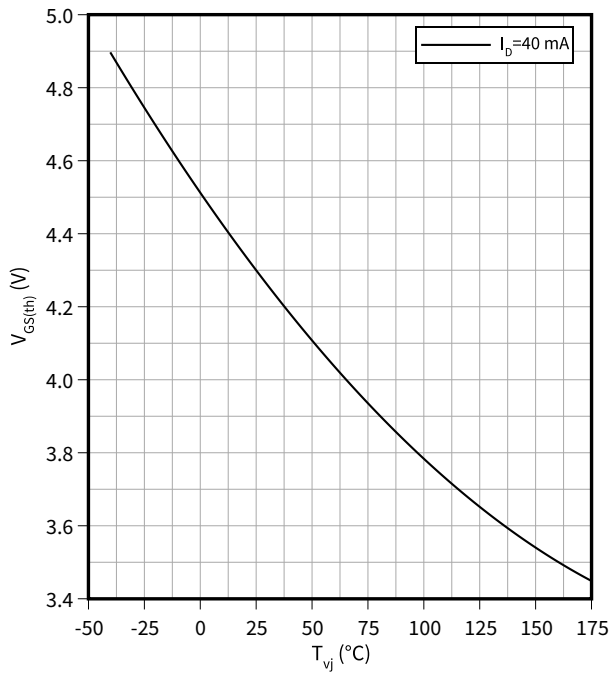
Transfer characteristic (typical), MOSFET

$I_D = f(V_{GS})$   
 $V_{DS} = 20\text{ V}$



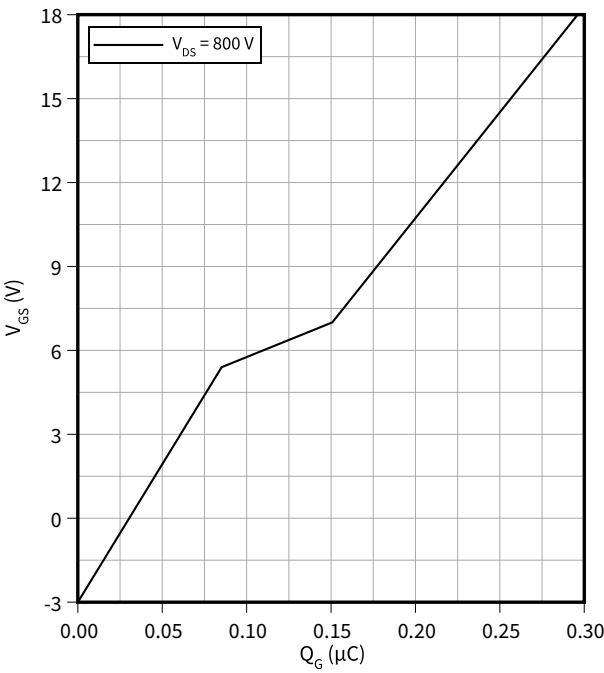
Gate-source threshold voltage (typical), MOSFET

$V_{GS(th)} = f(T_{vj})$   
 $V_{GS} = V_{DS}$



Gate charge characteristic (typical), MOSFET

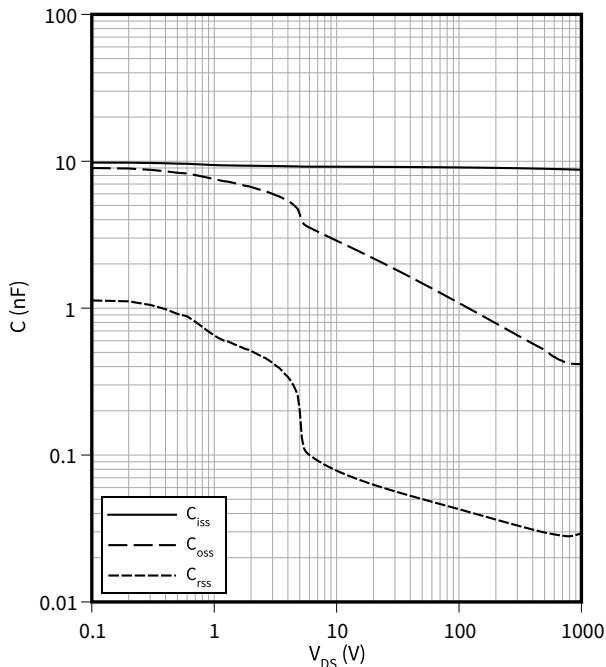
$V_{GS} = f(Q_G)$   
 $I_D = 100\text{ A}, T_{vj} = 25\text{ °C}$



5 Characteristics diagrams

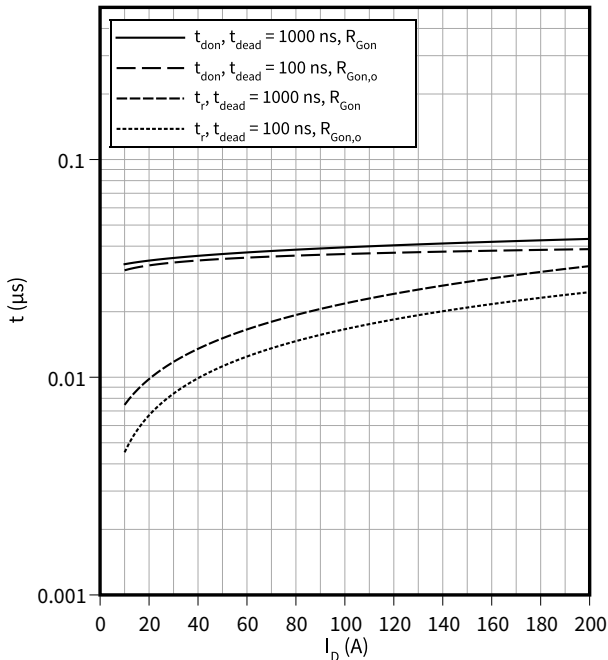
Capacity characteristic (typical), MOSFET

$C = f(V_{DS})$   
 $f = 100\text{ kHz}$ ,  $T_{vj} = 25\text{ °C}$ ,  $V_{GS} = 0\text{ V}$



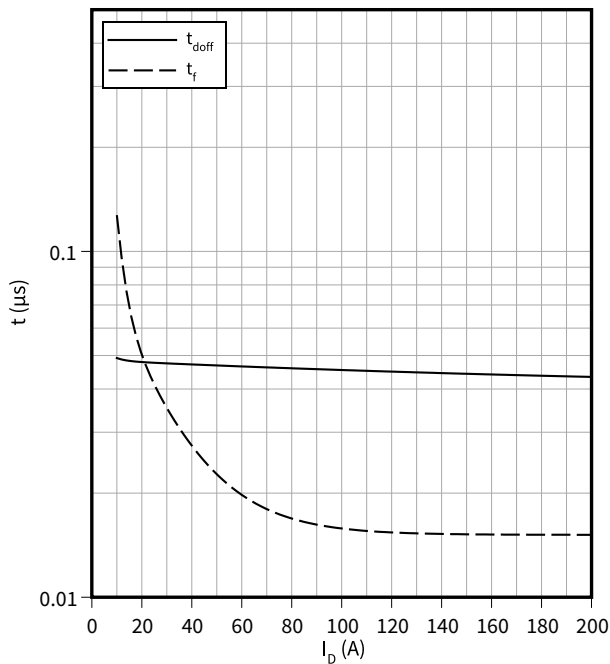
Switching times (typical), MOSFET

$t = f(I_D)$   
 $V_{DD} = 600\text{ V}$ ,  $R_{Gon} = 7.5\text{ }\Omega$ ,  $R_{Gon,o} = 4.7\text{ }\Omega$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GS} = -3/18\text{ V}$



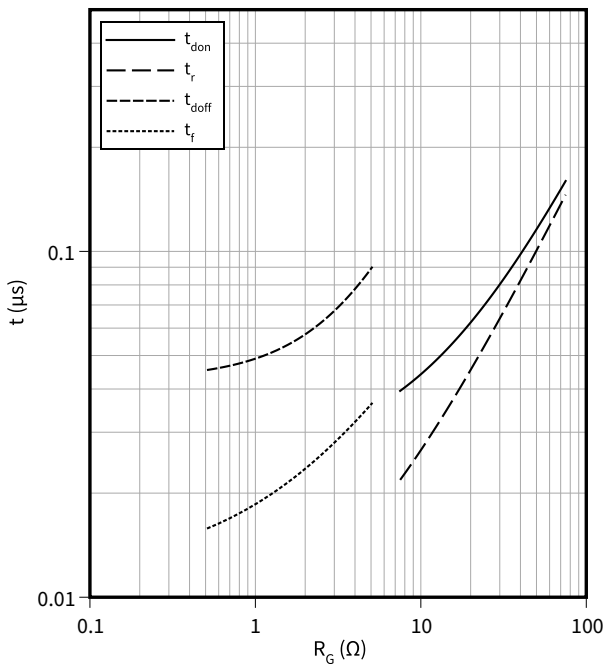
Switching times (typical), MOSFET

$t = f(I_D)$   
 $R_{Goff} = 0.51\text{ }\Omega$ ,  $V_{DD} = 600\text{ V}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GS} = -3/18\text{ V}$



Switching times (typical), MOSFET

$t = f(R_G)$   
 $V_{DD} = 600\text{ V}$ ,  $t_{dead} = 1000\text{ ns}$ ,  $I_D = 100\text{ A}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GS} = -3/18\text{ V}$

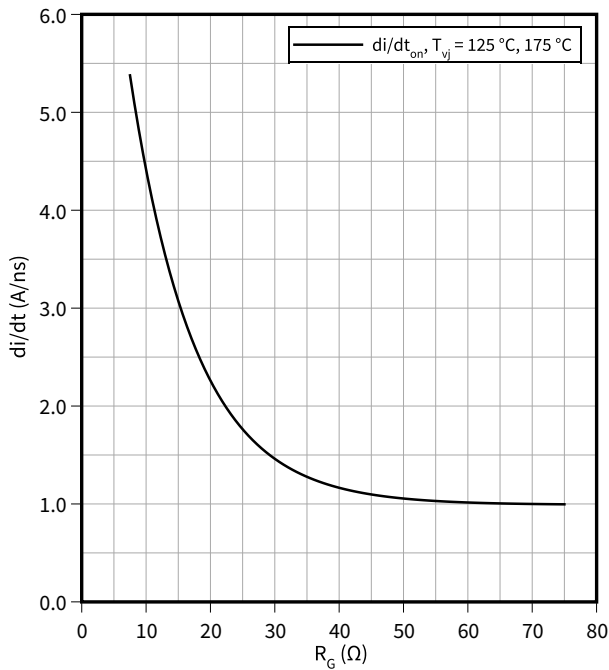


5 Characteristics diagrams

Current slope (typical), MOSFET

$di/dt = f(R_G)$

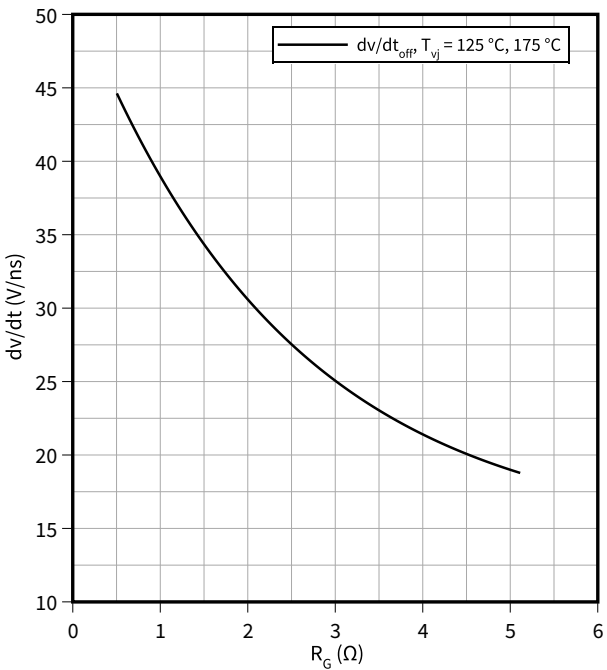
$V_{DD} = 600\text{ V}$ ,  $t_{dead} = 1000\text{ ns}$ ,  $I_D = 100\text{ A}$ ,  $V_{GS} = -3/18\text{ V}$



Voltage slope (typical), MOSFET

$dv/dt = f(R_G)$

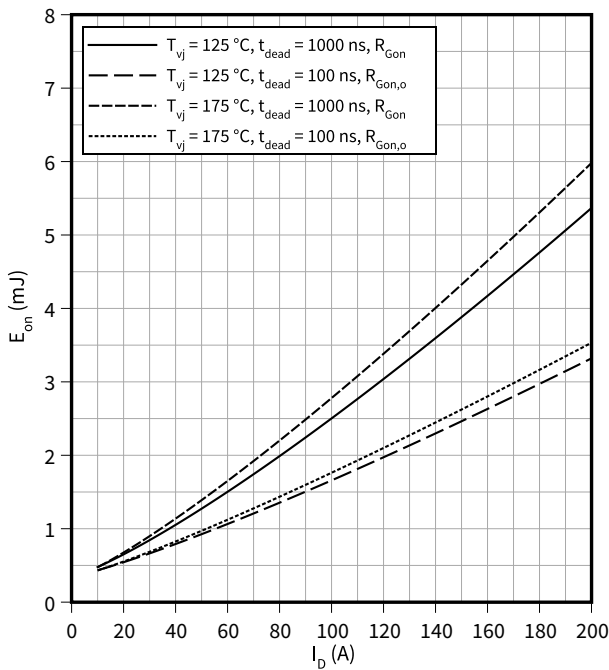
$V_{DD} = 600\text{ V}$ ,  $I_D = 100\text{ A}$ ,  $V_{GS} = -3/18\text{ V}$



Switching losses (typical), MOSFET

$E_{on} = f(I_D)$

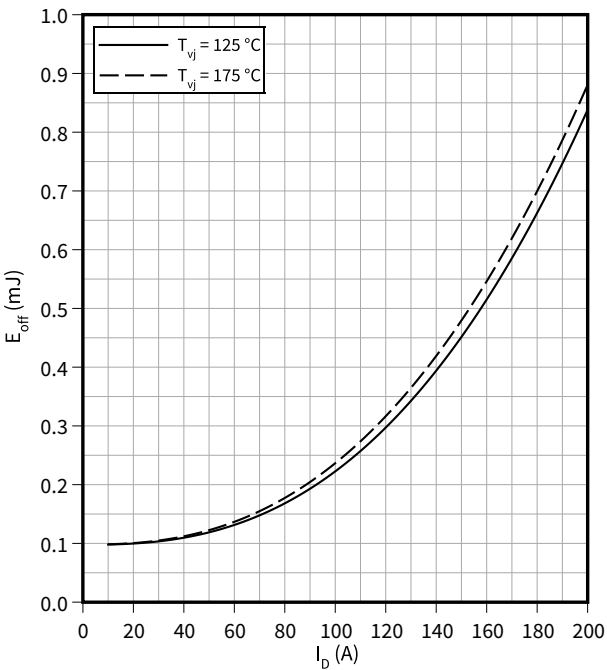
$V_{DD} = 600\text{ V}$ ,  $R_{Gon} = 7.5\text{ }\Omega$ ,  $R_{Gon,o} = 4.7\text{ }\Omega$ ,  $V_{GS} = -3/18\text{ V}$



Switching losses (typical), MOSFET

$E_{off} = f(I_D)$

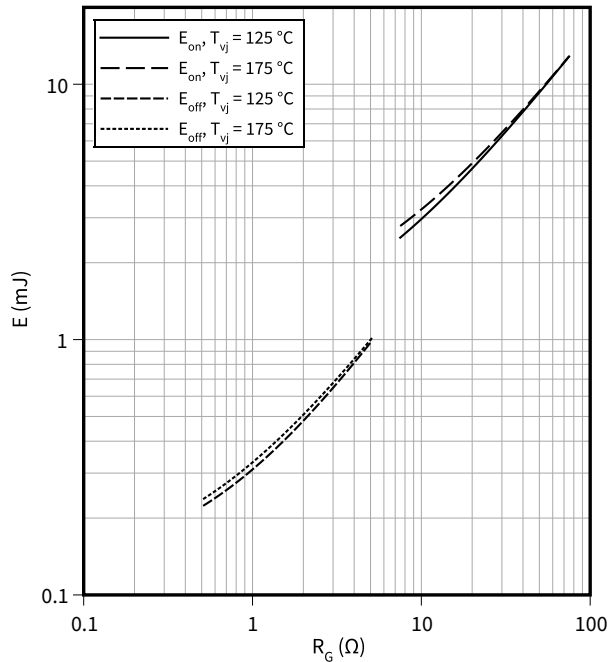
$R_{Goff} = 0.51\text{ }\Omega$ ,  $V_{DD} = 600\text{ V}$ ,  $V_{GS} = -3/18\text{ V}$



5 Characteristics diagrams

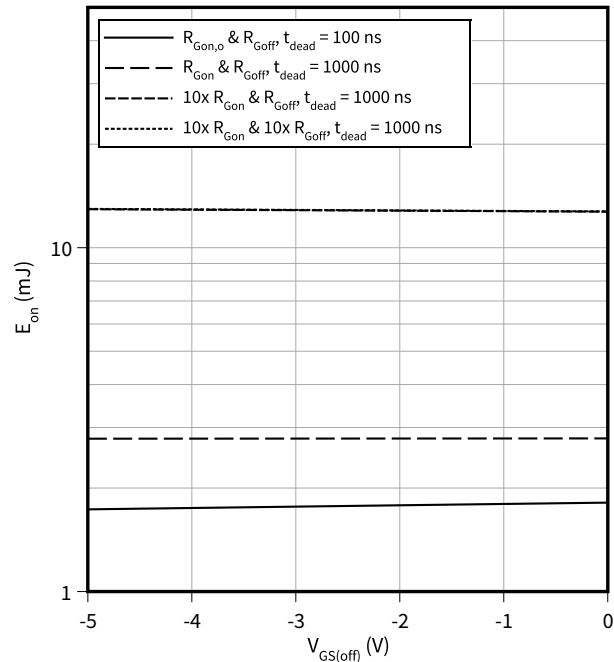
Switching losses (typical), MOSFET

$E = f(R_G)$   
 $V_{DD} = 600\text{ V}$ ,  $t_{dead} = 1000\text{ ns}$ ,  $I_D = 100\text{ A}$ ,  $V_{GS} = -3/18\text{ V}$



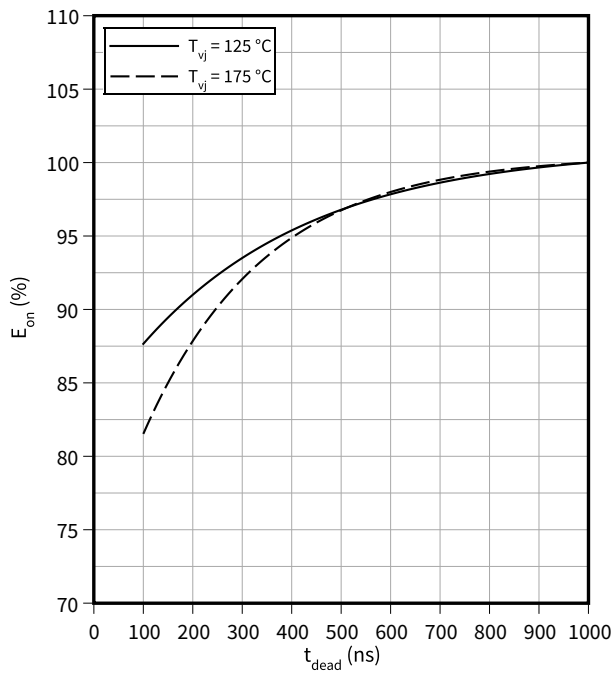
Switching losses (typical), MOSFET

$E_{on} = f(V_{GS(off)})$   
 $R_{Goff} = 0.51\text{ }\Omega$ ,  $V_{DD} = 600\text{ V}$ ,  $R_{Gon} = 7.5\text{ }\Omega$ ,  $V_{GS(on)} = 18\text{ V}$ ,  $I_D = 100\text{ A}$ ,  $R_{Gon,o} = 4.7\text{ }\Omega$ ,  $T_{vj} = 175\text{ }^\circ\text{C}$



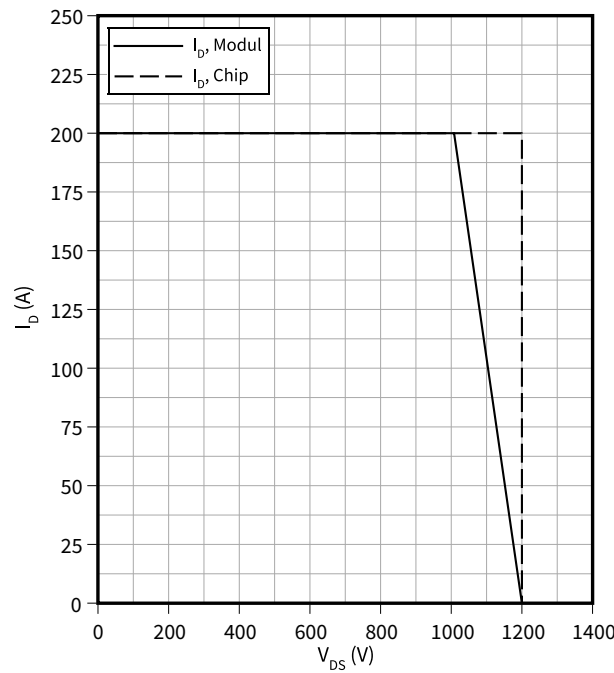
Switching losses (typical), MOSFET

$E_{on} = f(t_{dead})$   
 $R_{Gon} = 7.5\text{ }\Omega$ ,  $I_D = 100\text{ A}$ ,  $V_{DD} = 600\text{ V}$ ,  $V_{GS} = -3/18\text{ V}$



Reverse bias safe operating area (RBSOA), MOSFET

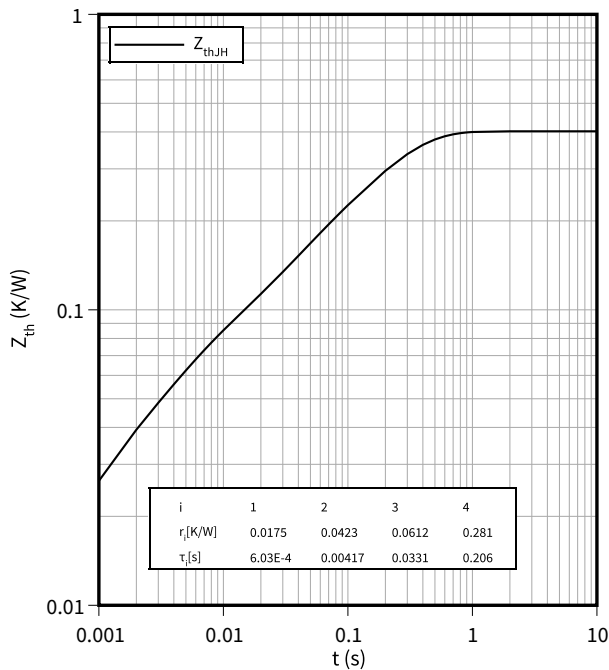
$I_D = f(V_{DS})$   
 $R_{Goff} = 0.51\text{ }\Omega$ ,  $T_{vj} = 175\text{ }^\circ\text{C}$ ,  $V_{GS} = -3/18\text{ V}$



5 Characteristics diagrams

Transient thermal impedance, MOSFET

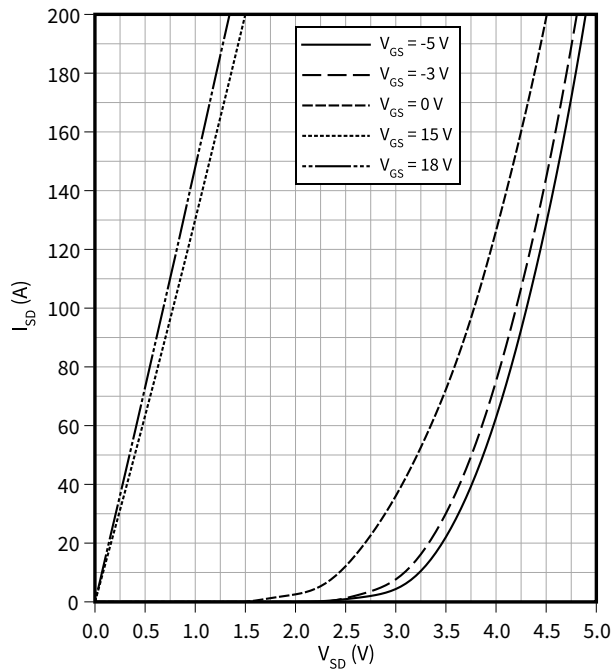
$Z_{th} = f(t)$



Forward characteristic body diode (typical), MOSFET

$I_{SD} = f(V_{SD})$

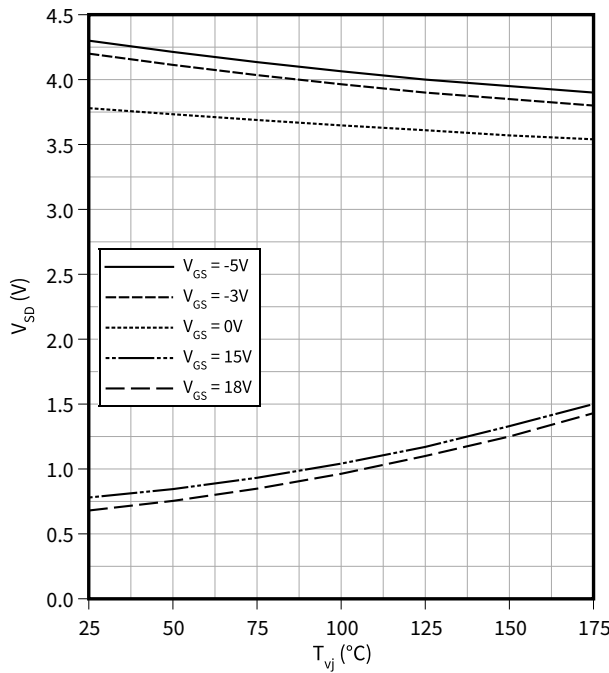
$T_{vj} = 25\text{ }^{\circ}\text{C}$



Forward voltage of body diode (typical), MOSFET

$V_{SD} = f(T_{vj})$

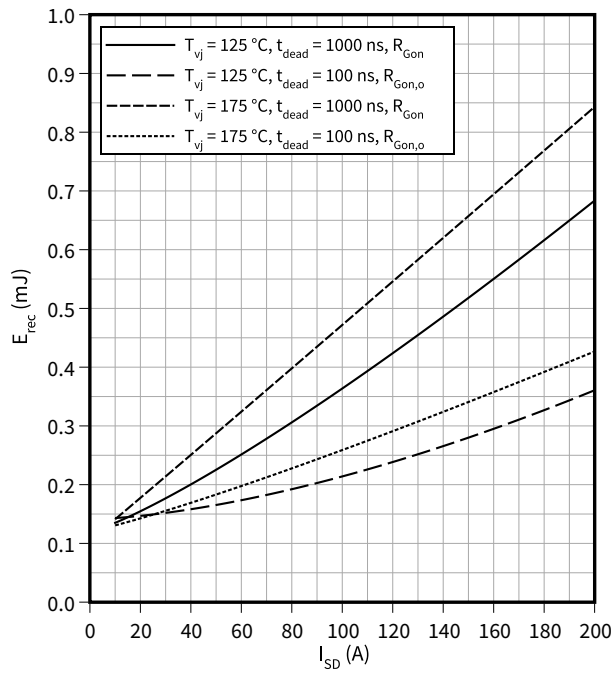
$I_{SD} = 100\text{ A}$



Switching losses body diode (typical), MOSFET

$E_{rec} = f(I_{SD})$

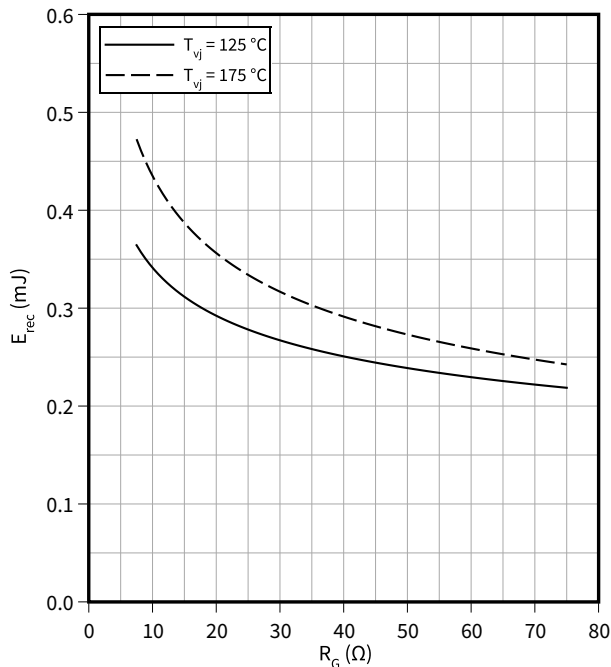
$R_{Gon} = 7.5\text{ }\Omega$ ,  $R_{Gon,o} = 4.7\text{ }\Omega$ ,  $V_{DD} = 600\text{ V}$



5 Characteristics diagrams

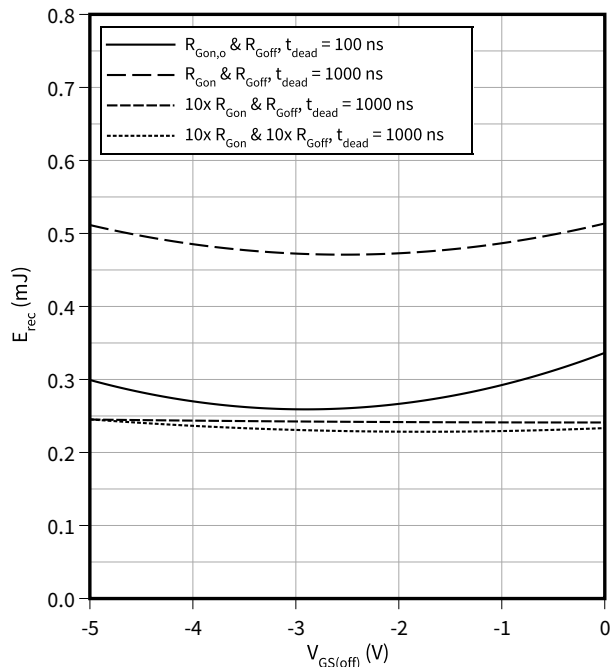
Switching losses body diode (typical), MOSFET

$E_{rec} = f(R_G)$   
 $t_{dead} = 1000\text{ ns}$ ,  $I_{SD} = 100\text{ A}$ ,  $V_{DD} = 600\text{ V}$



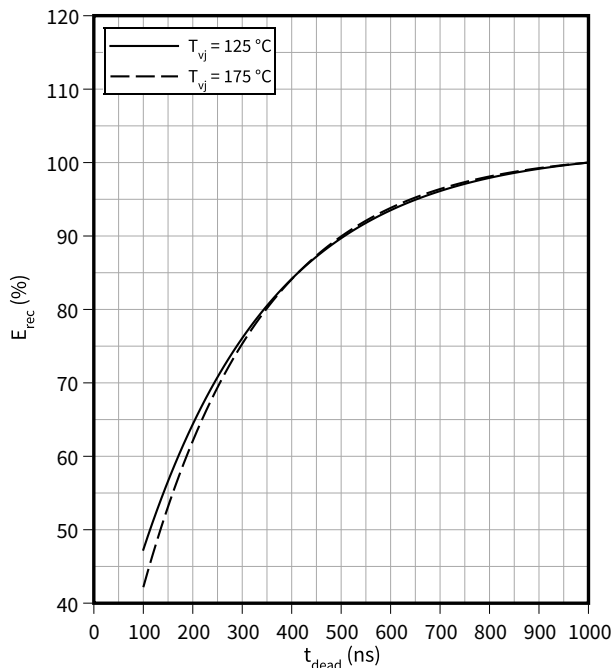
Switching losses body diode (typical), MOSFET

$E_{rec} = f(V_{GS(off)})$   
 $R_{Goff} = 0.51\text{ }\Omega$ ,  $R_{Gon} = 7.5\text{ }\Omega$ ,  $V_{GS(on)} = 18\text{ V}$ ,  $I_{SD} = 100\text{ A}$ ,  
 $R_{Gon,o} = 4.7\text{ }\Omega$ ,  $V_{DD} = 600\text{ V}$ ,  $T_{vj} = 175\text{ }^\circ\text{C}$



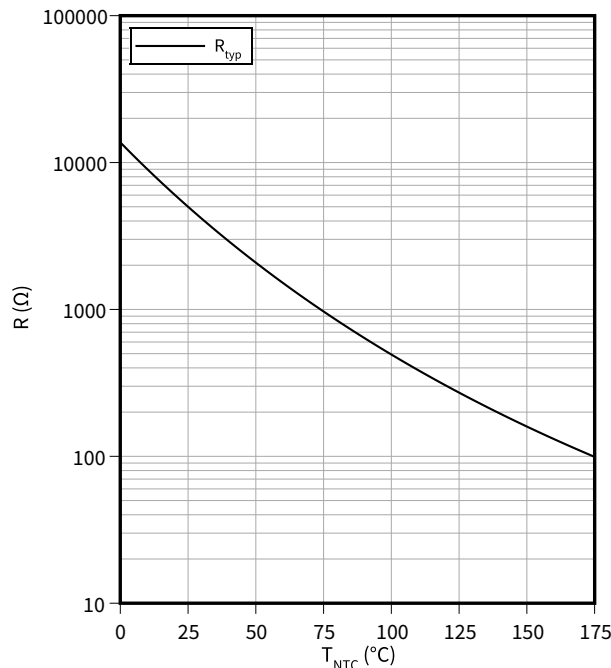
Switching losses body diode (typical), MOSFET

$E_{rec} = f(t_{dead})$   
 $R_{Gon} = 7.5\text{ }\Omega$ ,  $I_D = 100\text{ A}$ ,  $V_{DD} = 600\text{ V}$ ,  $V_{GS} = -3/18\text{ V}$



Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



6 Circuit diagram

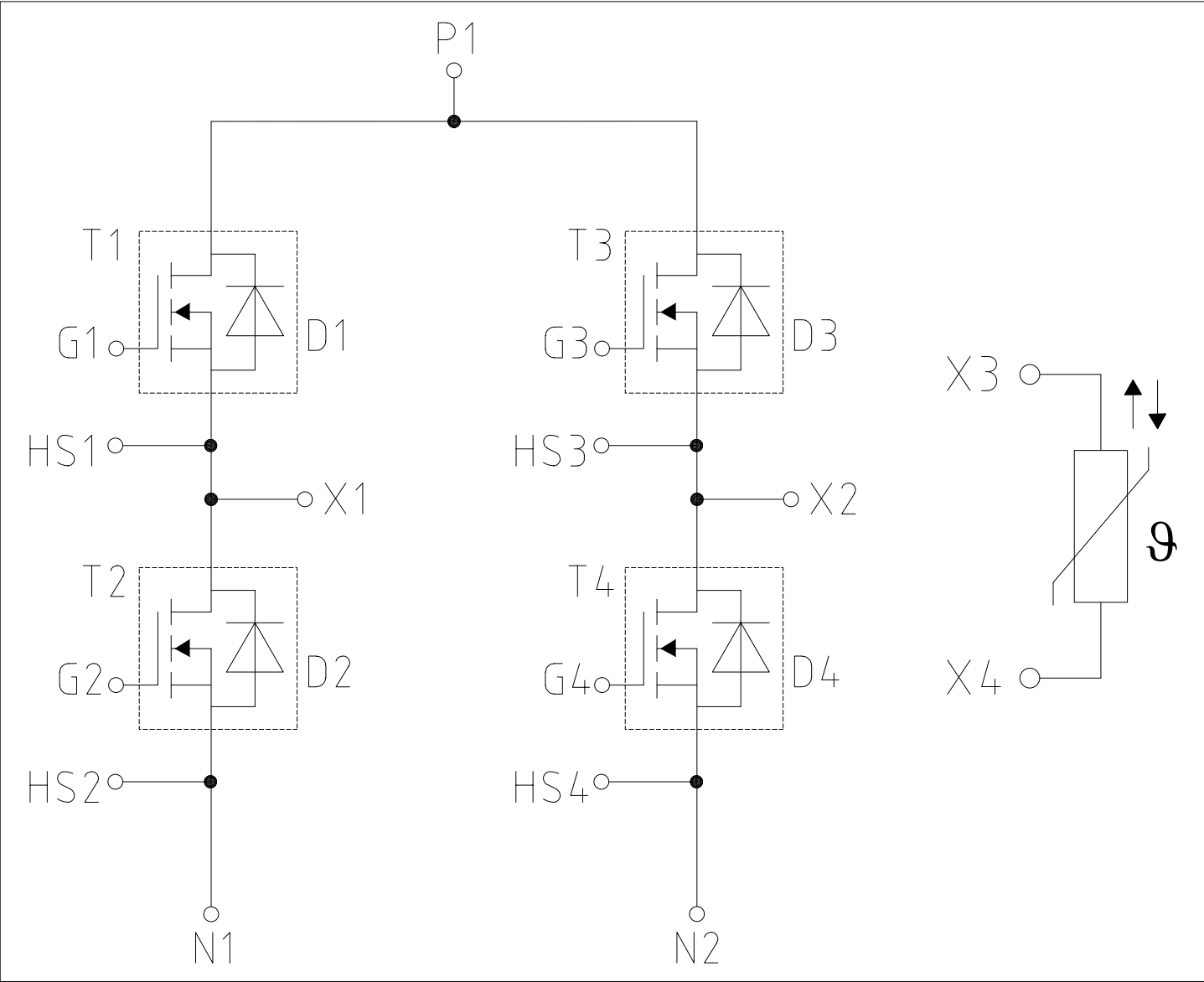
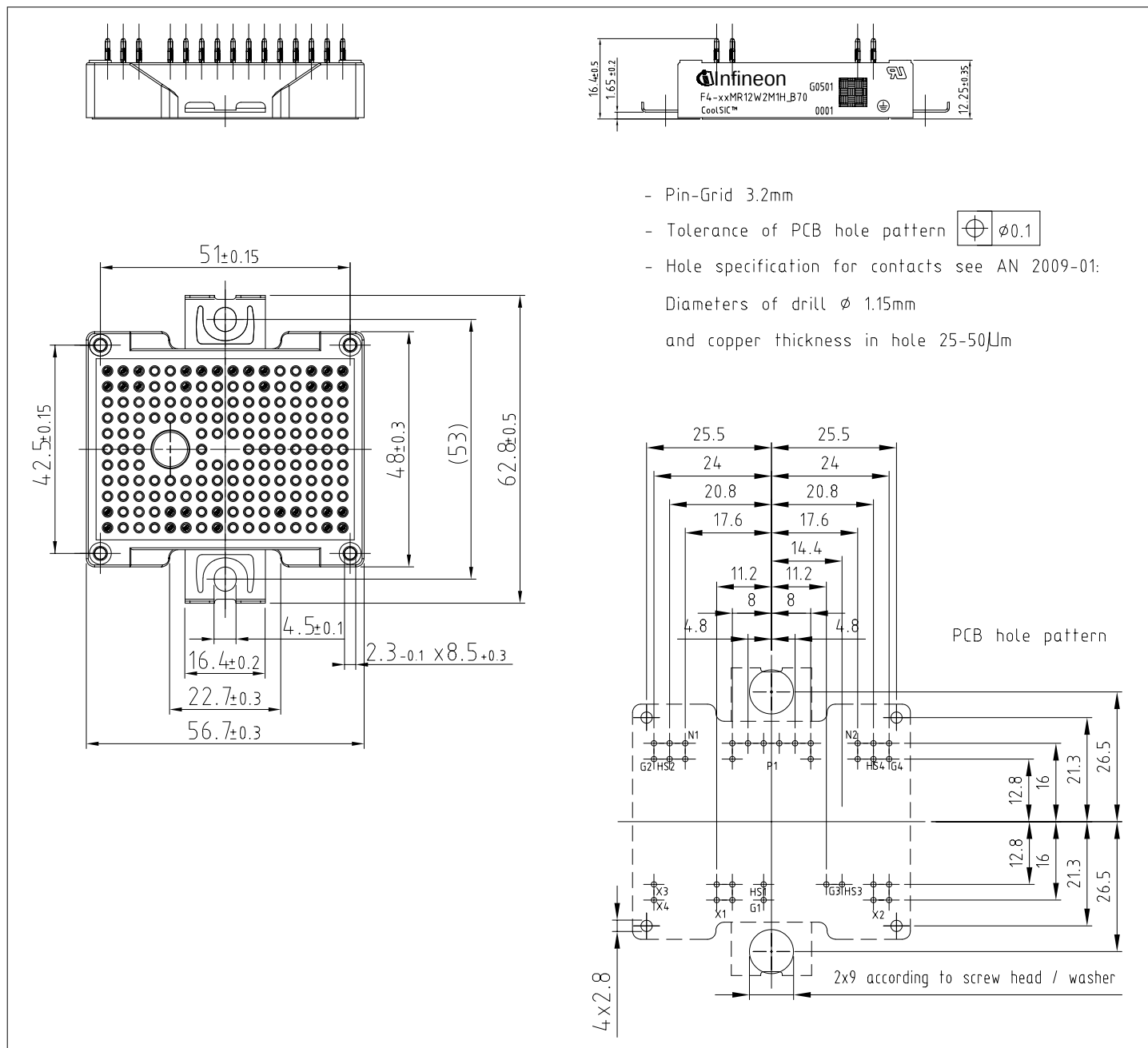


Figure 1

## 7 Package outlines



### Figure 2

8 Module label code

| Module label code |                                                                                                                                                                                                                                            |         |                 |
|-------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|-----------------|
| Code format       | Data Matrix                                                                                                                                                                                                                                |         | Barcode Code128 |
| Encoding          | ASCII text                                                                                                                                                                                                                                 |         | Code Set A      |
| Symbol size       | 16x16                                                                                                                                                                                                                                      |         | 23 digits       |
| Standard          | IEC24720 and IEC16022                                                                                                                                                                                                                      |         | IEC8859-1       |
| Code content      | Content                                                                                                                                                                                                                                    | Digit   | Example         |
|                   | Module serial number                                                                                                                                                                                                                       | 1 – 5   | 71549           |
|                   | Module material number                                                                                                                                                                                                                     | 6 - 11  | 142846          |
|                   | Production order number                                                                                                                                                                                                                    | 12 - 19 | 55054991        |
|                   | Date code (production year)                                                                                                                                                                                                                | 20 – 21 | 15              |
|                   | Date code (production week)                                                                                                                                                                                                                | 22 – 23 | 30              |
| Example           | <div></div> <div>7154914284655054991153071549142846550549911530</div> |         |                 |

Figure 3



Revision history

Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 0.10              | 2022-08-03      | Initial version        |
| 0.20              | 2023-06-09      | Preliminary datasheet  |
| 1.00              | 2025-02-27      | Final datasheet        |

## Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

**Edition 2025-02-27**

**Published by**

**Infineon Technologies AG**  
**81726 Munich, Germany**

**© 2025 Infineon Technologies AG**  
**All Rights Reserved.**

**Do you have a question about any aspect of this document?**

**Email: [erratum@infineon.com](mailto:erratum@infineon.com)**

**Document reference**  
**IFX-ABB639-003**

## Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenhheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

## Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.